

# 1. Global joint venture starts operations as WeEn Semiconductors

Dear customer,

As from November 9th, 2015 NXP Semiconductors N.V. and Beijing JianGuang Asset Management Co. Ltd established Bipolar Power joint venture (JV), **WeEn Semiconductors**, which will be used in future Bipolar Power documents together with new contact details.

In this document where the previous NXP references remain, please use the new links as shown below.

WWW - For www.nxp.com use www.ween-semi.com

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If you have any questions related to this document, please contact our nearest sales office via email or phone (details via <u>salesaddresses@ween-semi.com</u>).

Thank you for your cooperation and understanding,

WeEn Semiconductors



# **BT145 series**

## GENERAL DESCRIPTION

Glass passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

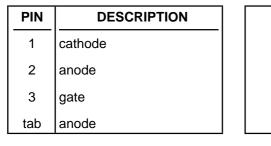
#### **PINNING - TO220AB**

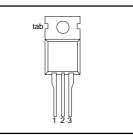
# QUICK REFERENCE DATA

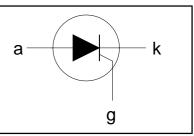
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V <sub>drm</sub> , V <sub>rrm</sub> I <sub>t(av)</sub> I <sub>t(rms)</sub> I <sub>tsm</sub>	BT145- Repetitive peak off-state voltages Average on-state current RMS on-state current Non-repetitive peak on-state current	<b>500R</b> 500 16 25 300	<b>600R</b> 600 16 25 300	<b>800R</b> 800 16 25 300	V A A A

#### **PIN CONFIGURATION**

#### SYMBOL







#### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT	
V <sub>drm</sub> , V <sub>rrm</sub>	Repetitive peak off-state voltages		-	<b>-500R</b> 500 <sup>1</sup>	<b>-600R</b> 600 <sup>1</sup>	<b>-800R</b> 800	V
I <sub>T(AV)</sub> I <sub>T(RMS)</sub> I <sub>TSM</sub>	Average on-state current RMS on-state current Non-repetitive peak on-state current	half sine wave; $T_{mb} \le 101$ °C all conduction angles half sine wave; $T_j = 25$ °C prior to surge	-		16 25		A A
12.		t = 10 ms t = 8.3 ms	-		300 330		A A
l²t dl <sub>⊤</sub> /dt	I <sup>2</sup> t for fusing Repetitive rate of rise of on-state current after triggering		-		450 200		A²s A∕µs
I <sub>GM</sub> V <sub>GM</sub> V <sub>RGM</sub> P <sub>GM</sub>	Peak gate current Peak gate voltage Peak reverse gate voltage Peak gate power		- - -		5 5 20		A V V W
$\begin{array}{c} P_{G(AV)}^{om} \\ T_{stg}^{stg} \\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -		0.5 150 125		°℃

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<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

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## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub>	Thermal resistance		-	-	1.0	K/W
R <sub>th j-a</sub>	junction to mounting base Thermal resistance junction to ambient	in free air	-	60	-	K/W

## STATIC CHARACTERISTICS

 $T_j = 25$  °C unless otherwise stated

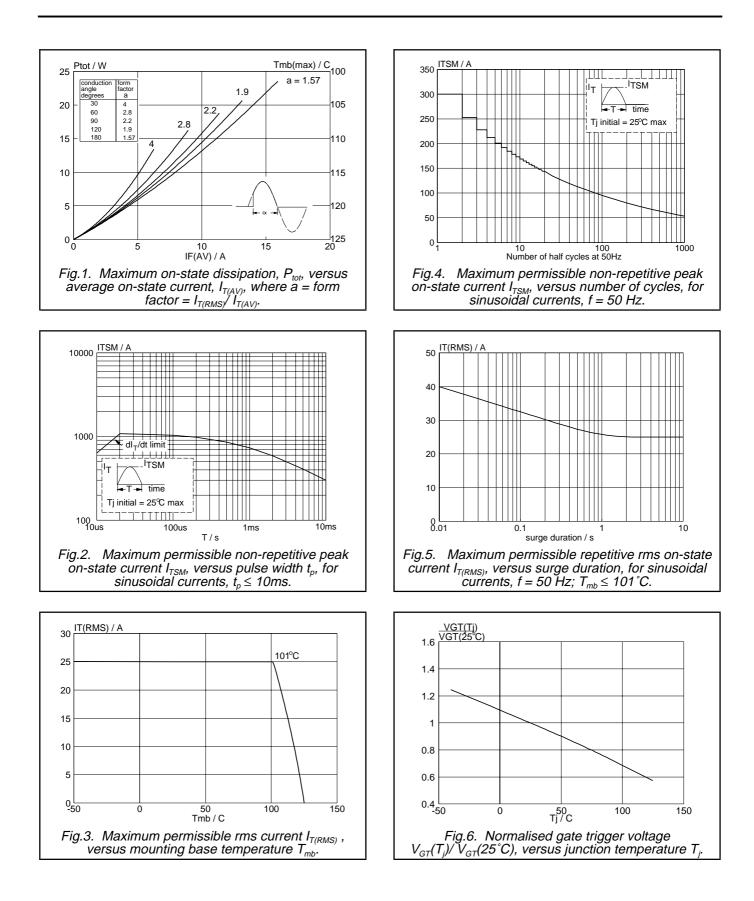
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>GT</sub>	Gate trigger current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$	-	5	35	mA
I I	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$	-	25	80	mA
	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$	-	20	60	mA
ν <sub>τ</sub>	On-state voltage	$I_{T} = 30 \text{ A}$	-	1.1	1.5	V
V <sub>GT</sub>	Gate trigger voltage	$\dot{V}_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$	-	0.6	1.0	V
0.		$V_{\rm D} = V_{\rm DRM(max)}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125 \ ^{\circ}\text{C}$	0.25	0.4	-	V
I <sub>D</sub> , I <sub>R</sub>	Off-state leakage current	$V_D^{D} = V_{DRM(max)}^{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125 \text{°C}$	-	0.2	1.0	mA

## **DYNAMIC CHARACTERISTICS**

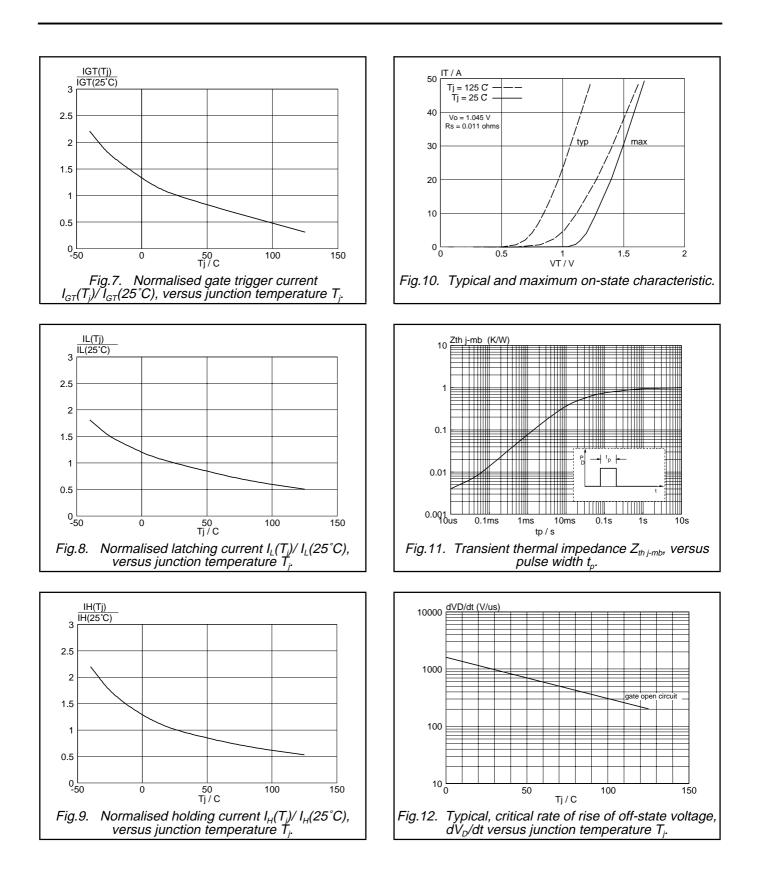
 $T_j = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV <sub>D</sub> /dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; gate open circuit	200	500	-	V/µs
t <sub>gt</sub>	Gate controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A/us}$	-	2	-	μs
t <sub>q</sub>	Circuit commutated turn-off time	$V_{D}^{o} = 67\% V_{DRM(max)}^{i}$ ; T <sub>j</sub> = 125 °C; I <sub>TM</sub> = 50 A; V <sub>R</sub> = 25 V; dI <sub>TM</sub> /dt = 30 A/µs; dV <sub>D</sub> /dt = 50 V/µs	-	70	-	μs

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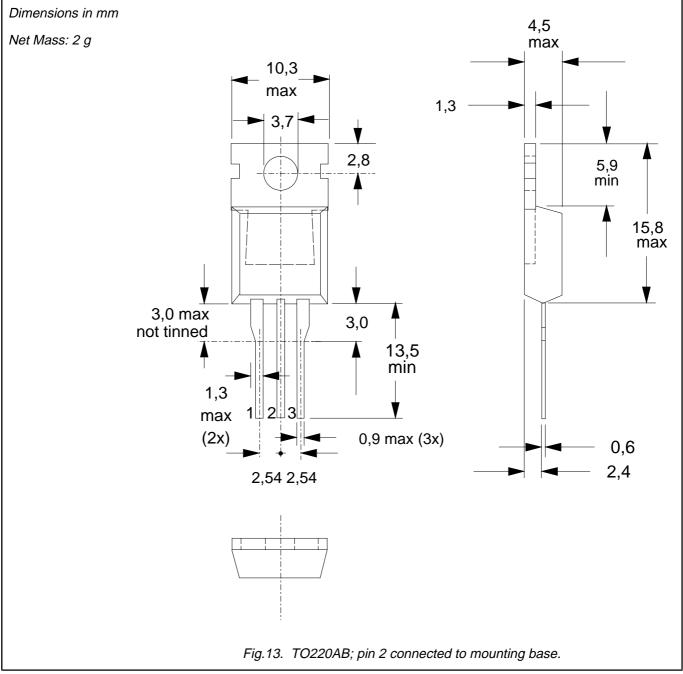


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## **MECHANICAL DATA**



Notes 1. Refer to mounting instructions for TO220 envelopes. 2. Epoxy meets UL94 V0 at 1/8".

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#### DEFINITIONS

Data sheet status					
Objective specification	cification This data sheet contains target or goal specifications for product development.				
Preliminary specification	ion This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information					
Where application information is given, it is advisory and does not form part of the specification.					
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## LIFE SUPPORT APPLICATIONS

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